

# Two-Phase Microchannel Thermosyphon Cooling System for Blade/2U Servers

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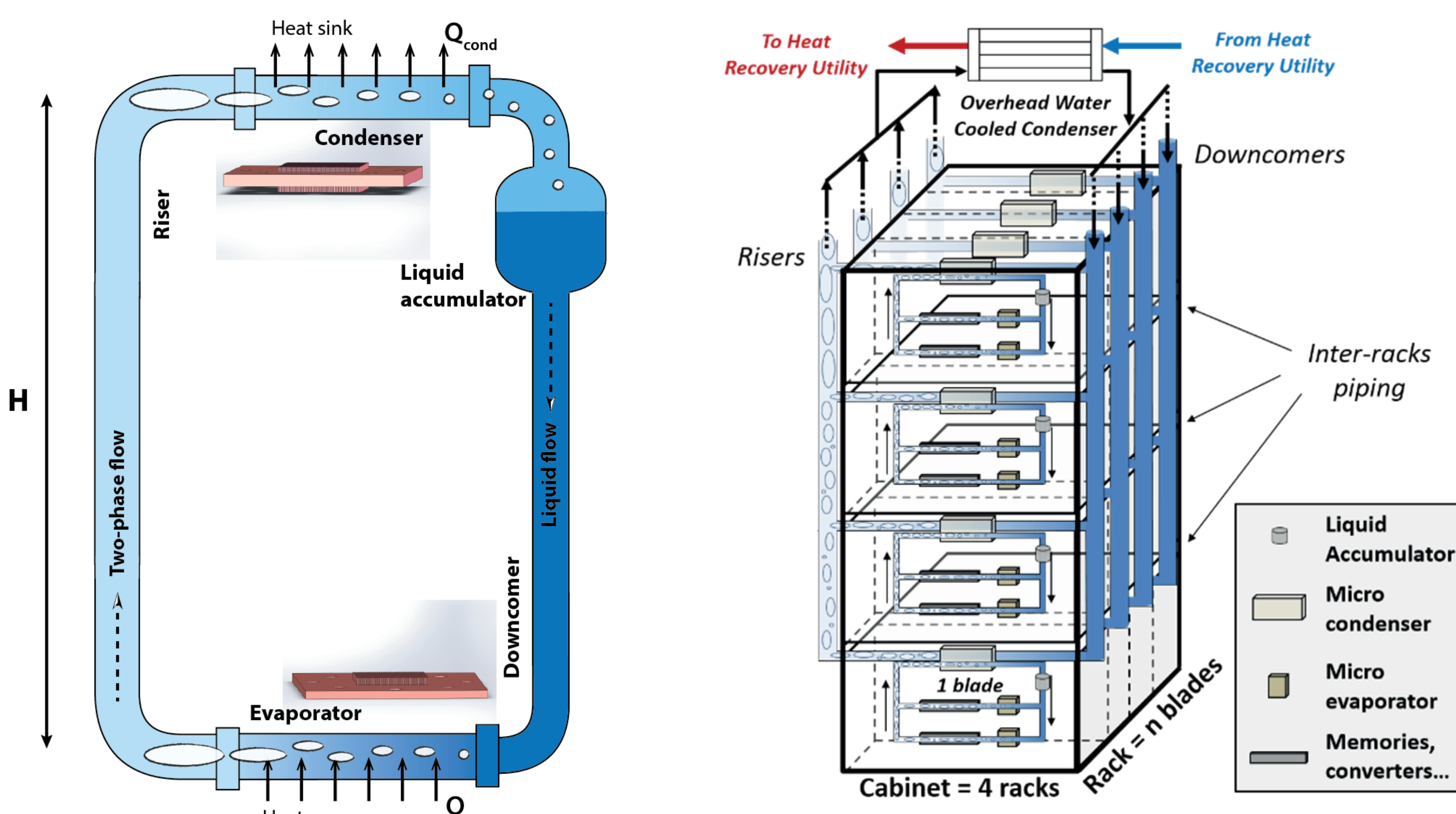
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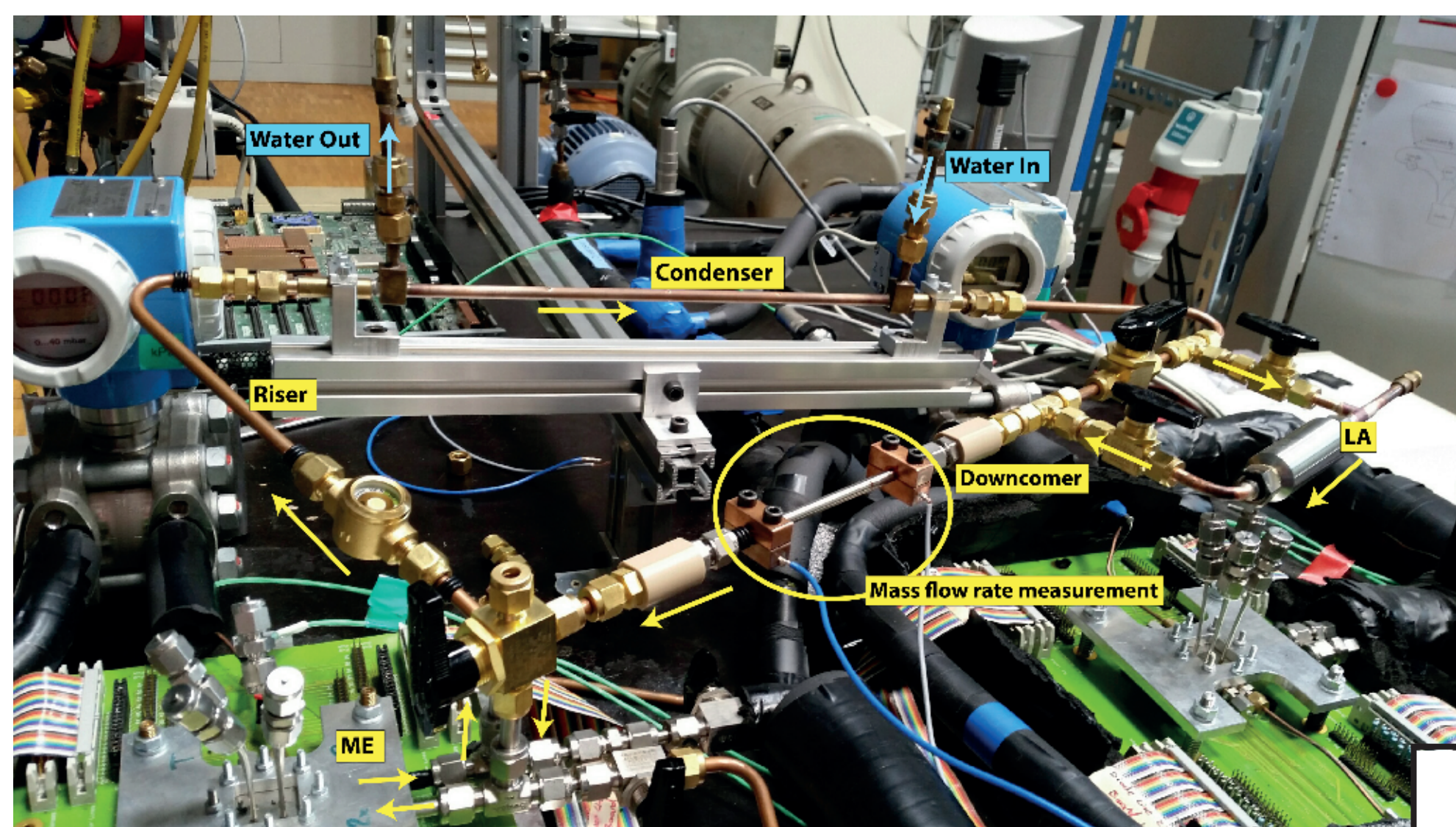
## 1 - Context and Motivation

Air TO On-chip 2phase TO Thermosyphon cooling in DC

- Better cooling performance
- Reduce the power consumption
- Allow the reuse of evacuated heat
- Gravity driven
- No power consumption
- Passive system control



## 2 - Experimental Test bench and Results

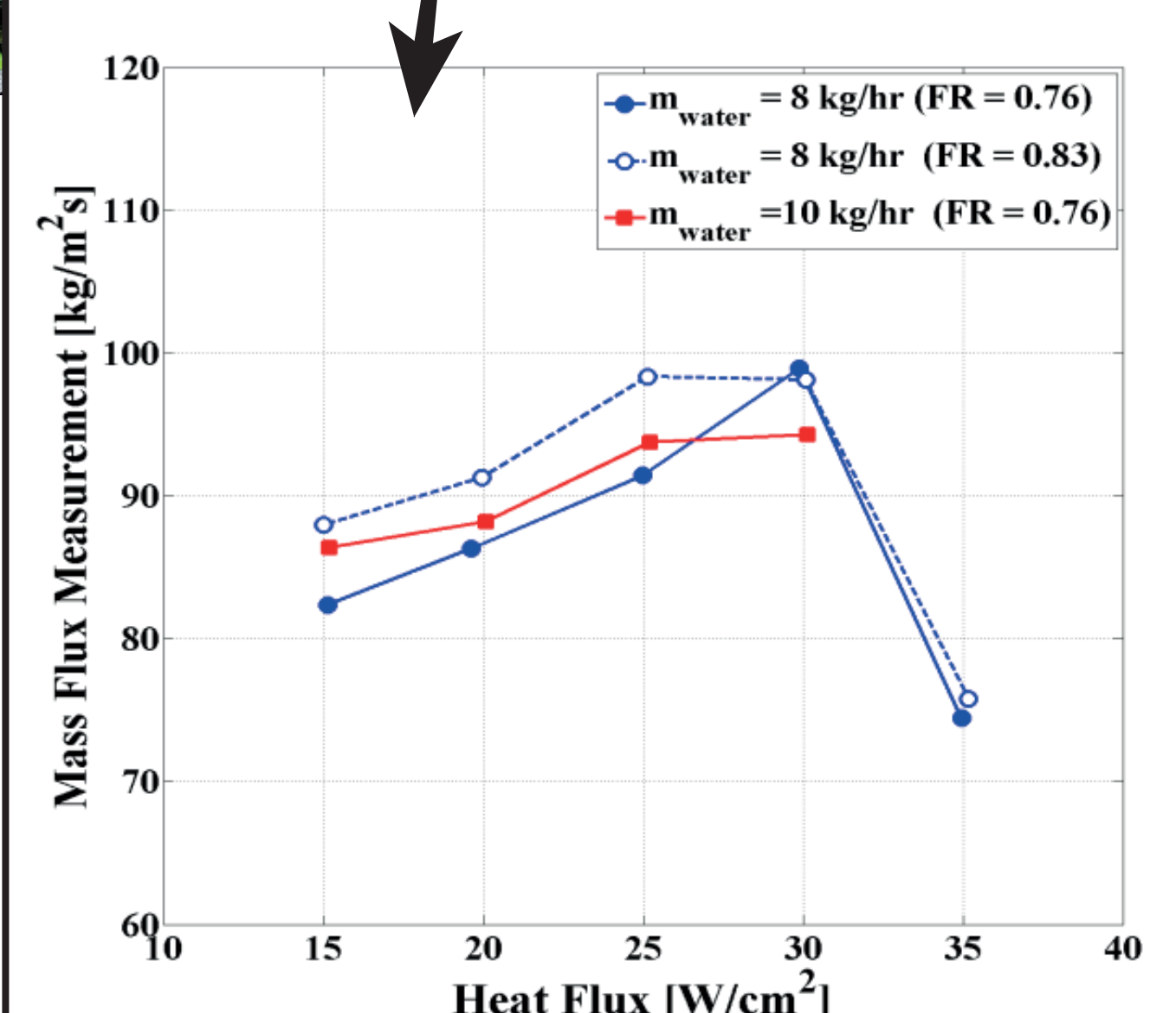


New **non intrusive** low mass flow rate measurement with an accuracy of about 8%

--> **Decisive for comprehension of phenomena ruling mini thermosyphon systems**

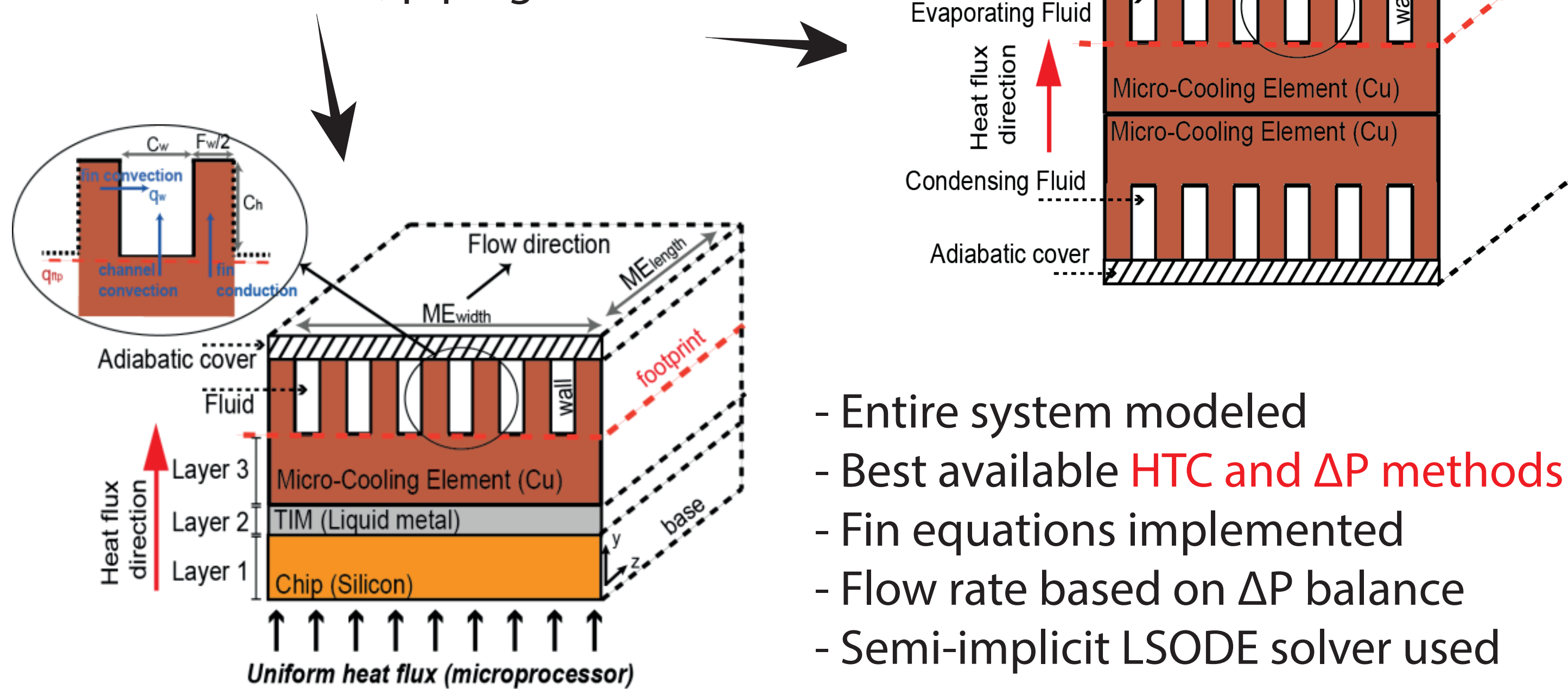
- Carry heat **15cm vertically** and 20cm horizontally
- Uniform Heat Fluxes tested up to  $61\text{W/cm}^2$
- Filling ratio from 60 to 83% (36 to 56g of R134a)
- Condenser Water flow rate from 6 to 12kg/h
- Condenser Water temperature from 12 to  $40^\circ\text{C}$

--> **Promising results achieved with heat sink performance similar as in pump mode and total system thermal resistance of about  $0.17\text{K/W}$ .**

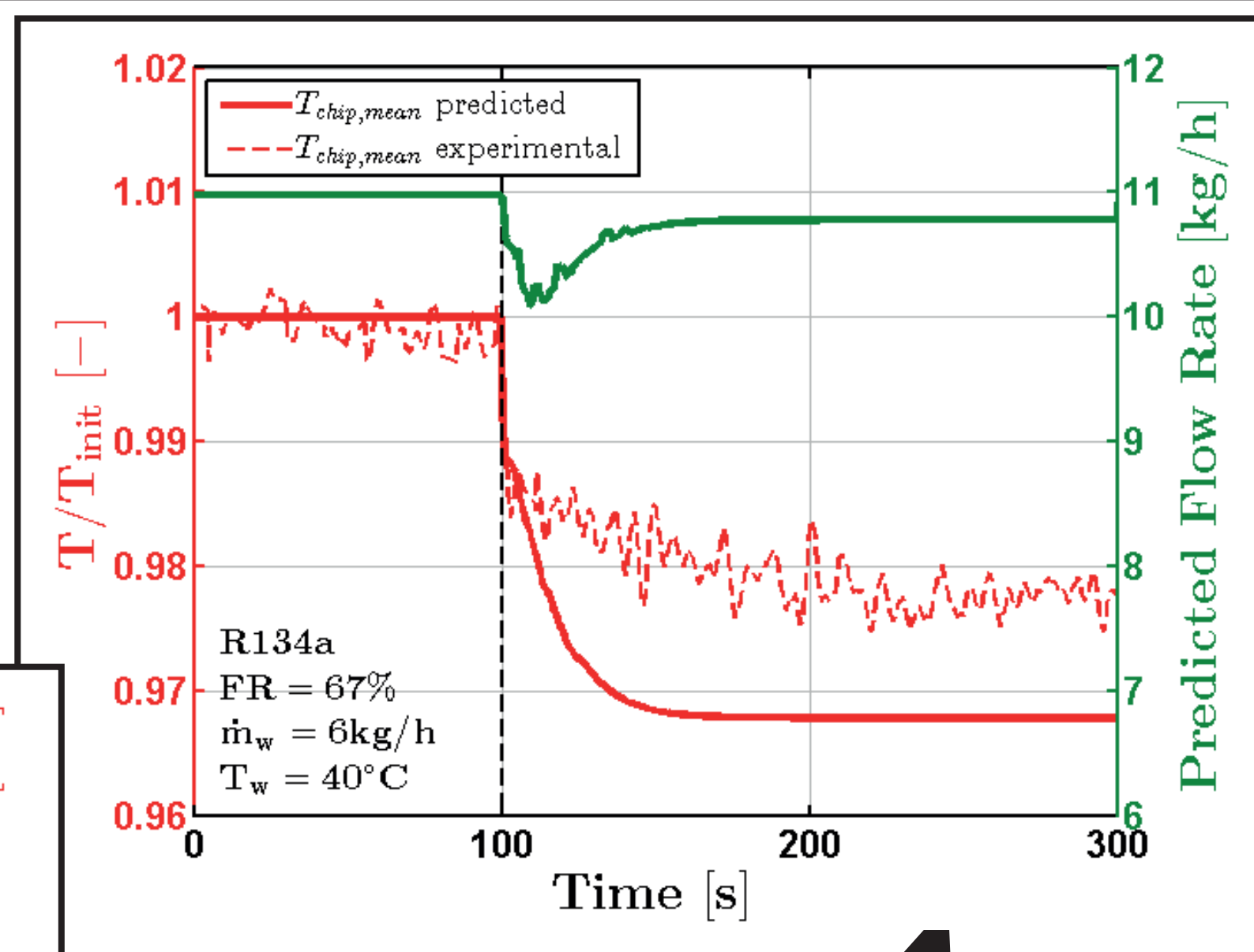
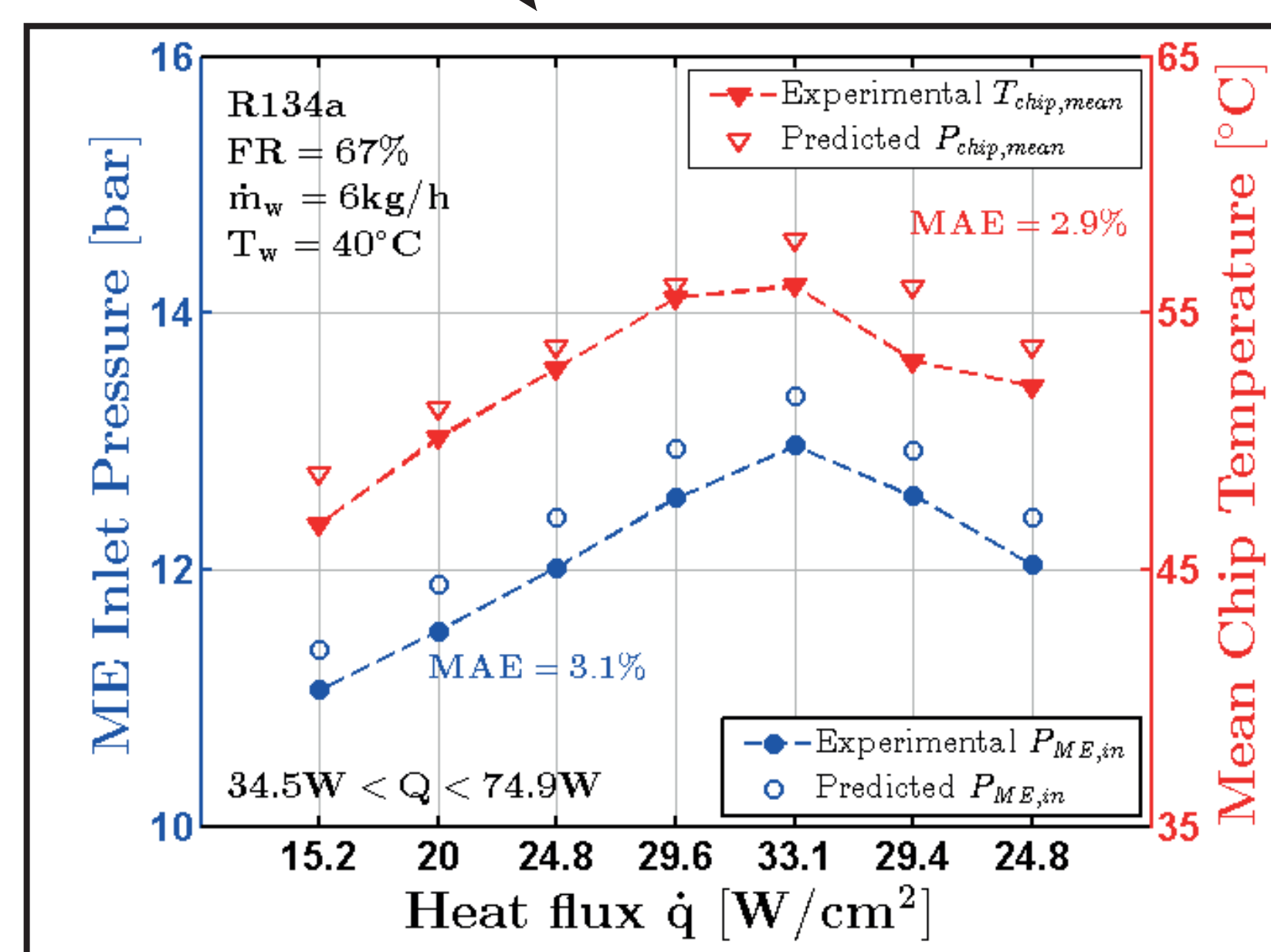


## 3 - Dynamic Modeling and Validation

- 1D Homogeneous flow model
- Thermodynamic equilibrium
- 2D conduction in ME package
- Lumped capacitance in accumulator
- **PDEs** in heat sink, piping and condenser

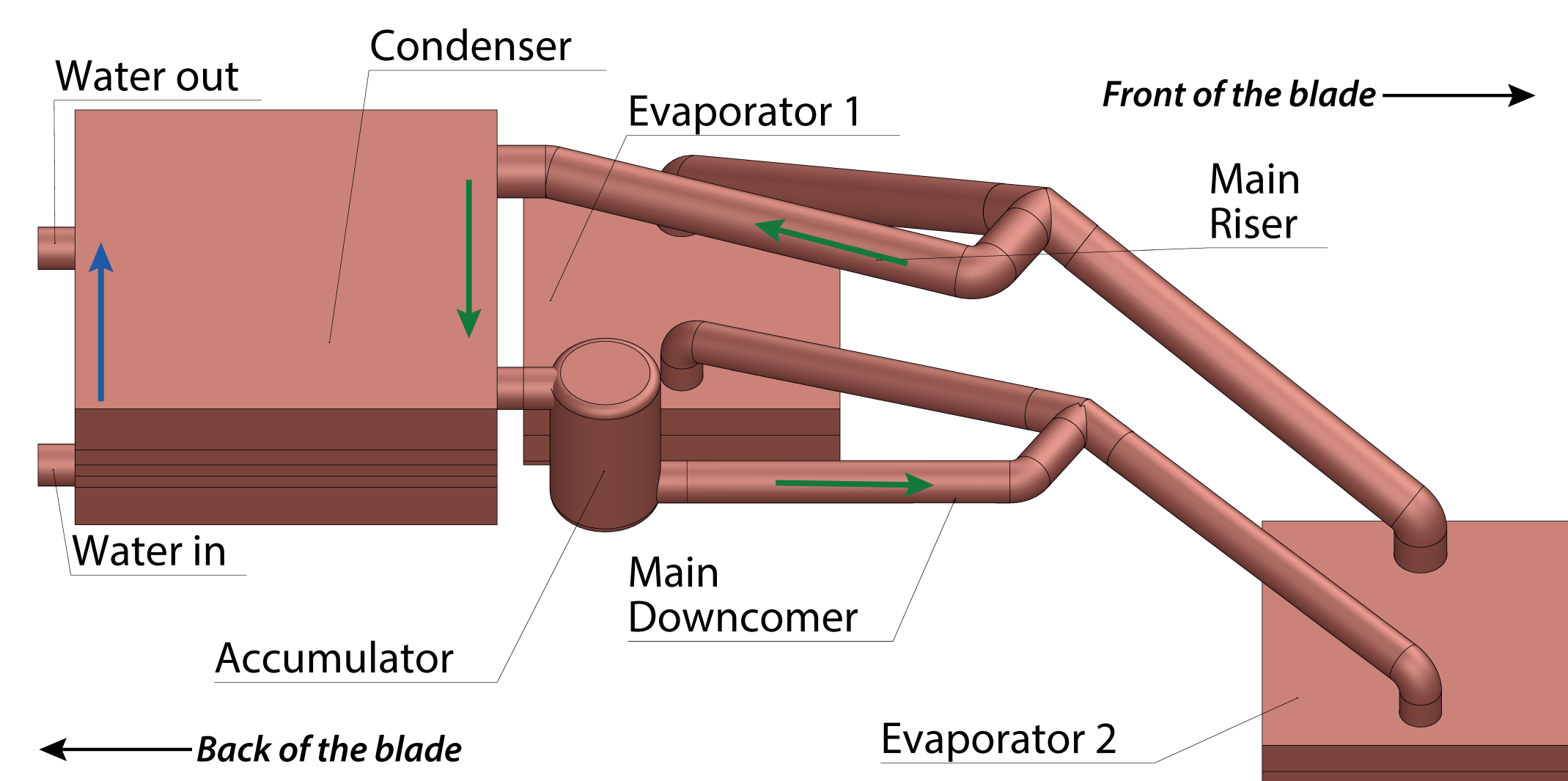


--> **6 steady-states predicted with MAE of 2.9 and 3.1% respectively for mean chip temperatures and heat sink inlet pressure.**

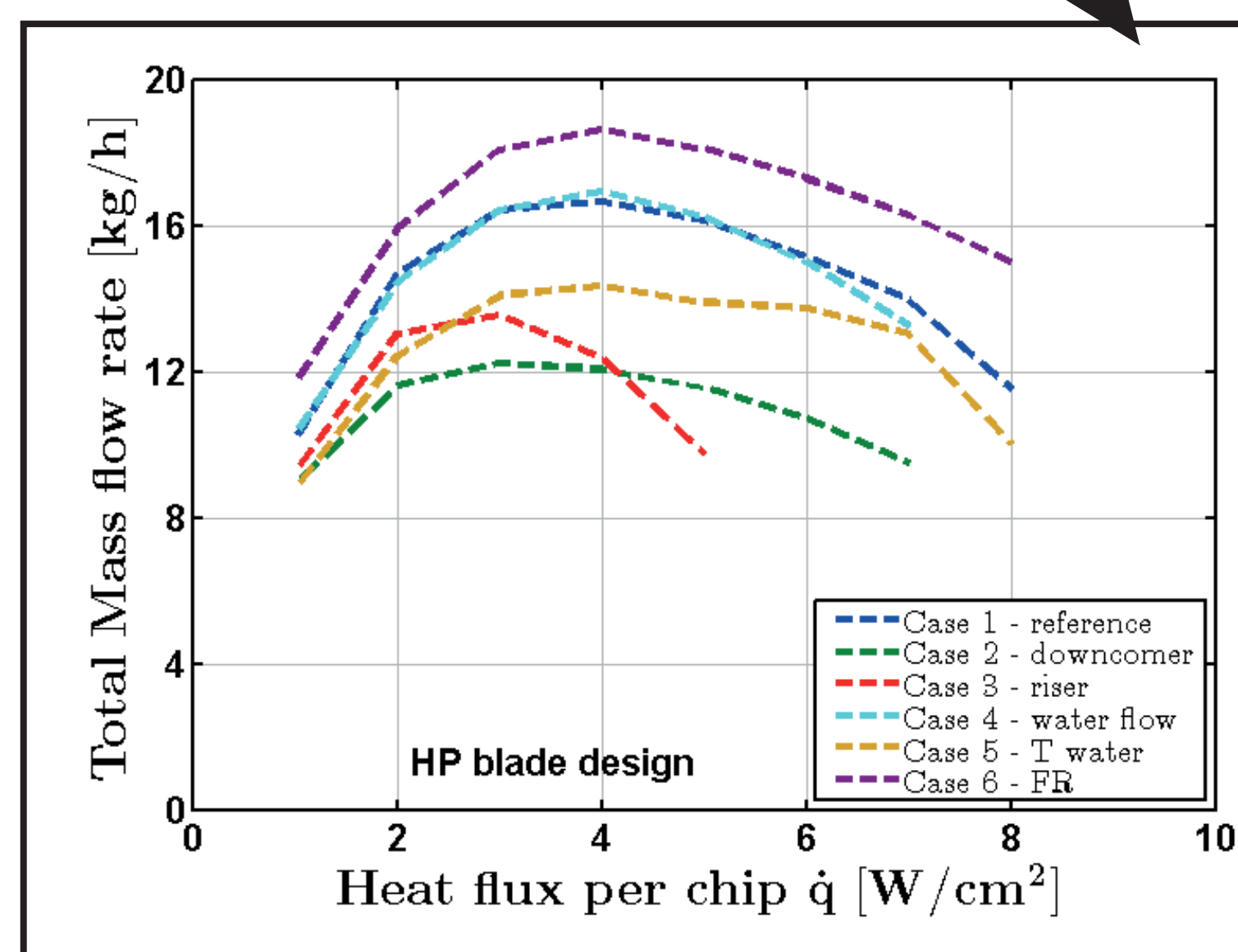


--> **Temporal predictions of heat load disturbance. Fast (conduction) and long (pressure transient) constant time reactions are both predicted. Additional insights with flow rate prediction**

## 4 - Application to 2U Servers



- Steady-state and dynamic simulations
- **Iteration geometry/simulations**
- Sensitivity analysis performed
- Unbalanced heat loads tested



--> **Theoretical multiple solutions found for the equilibrium mass flow rate**  
 --> **Desired flow distribution obtained for unbalanced heat loads**  
 --> **Safety factor of 1.3 obtained for the final geometry compared to the TDP. (Thermal Design Power)**

## 5 - Conclusions and Perspectives

- Fully instrumented **mini-thermosyphon built**
- New insights gained thanks to this laboratory setup
- **Dynamic model** of the entire system developed
- Validation of the code using the experimental setup
- Simulation code used to design a **2U server-scale thermosyphon** cooling system
- 4 part series of papers published in ITherm2016.

- 2U thermosyphon demonstrator **under manufacturing**
- Installation of the thermosyphon inside the 2U blade
- Monitor performance (power consumption and thermal characteristics) using a home-made Python-based platform and compare with air cooled blade
- Work continuing on a blade cooling server application

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